

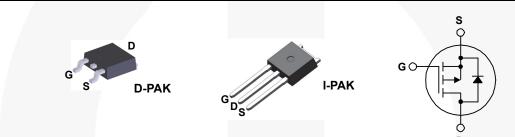
FQD17P06 / FQU17P06 P-Channel QFET[®] MOSFET -60 V, -12 A, 135 mΩ

Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- -12 A, -60 V, $R_{DS(on)}$ = 135 m Ω (Max.) @ V_{GS} = -10 V, I_D = -6 A
- Low Gate Charge (Typ. 21 nC)
- Low Crss (Typ. 80 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FQD17P06 / FQU17P06	Unit
V _{DSS}	Drain-Source V	/oltage		-60	V
I _D	Drain Current	- Continuous (T _C = 25°C)		-12	A
		- Continuous (T _C = 100°C)		-7.6	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	-48	A
V _{GSS}	Gate-Source Vo	oltage		± 25	V
E _{AS}	Single Pulsed A	Avalanche Energy	(Note 2)	300	mJ
I _{AR}	Avalanche Current (N		(Note 1)	-12	A
E _{AR}	Repetitive Avalanche Energy (Note		(Note 1)	4.4	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	-7.0	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *			2.5	W
	Power Dissipation ($T_C = 25^{\circ}C$)			44	W
	- Derate above 25°C			0.35	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds.			300	°C

Thermal Characteristics

Symbol	Parameter	FQD17P06 / FQU17P06	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.85	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	

* When mounted on the minimum pad size recommended (PCB Mount)

Package	Marking	and	Orderina	Information
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Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQD17P06TM	FQD17P06	DPAK	Tape and Reel	330 mm	16 mm	2500 units
FQU17P06TU	FQU17P06	IPAK	Tube	N/A	N/A	70 units

Flectrical Characteristics

Symbol	Parameter Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = -250 μ A	-60			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-0.06		V/°C
I _{DSS}	Zara Cata Valtaga Drain Current	V_{DS} = -60 V, V_{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 125°C			-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -25 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source $V_{GS} = -10 \text{ V}, I_D = -6.0 \text{ A}$			0.11	0.135	Ω
9 _{FS}	Forward Transconductance $V_{DS} = -30 \text{ V}, I_D = -6.0 \text{ A}$		·	8.7		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$ f = 1.0 MHz		690 325 80	900 420 105	pF pF pF
				00	100	pi
	Ing Characteristics			13	35	ns
t _{d(on)} t _r	Turn-On Rise Time	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -8.5 \text{ A},$		100	210	ns
	Turn-Off Delay Time	$R_{G} = 25 \Omega$		22	55	ns
t _{d(off)} t _f	Turn-Off Fall Time	(Note 4)		60	130	ns
ч Q _q	Total Gate Charge	. ,		21	27	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = -48 \text{ V}, \text{ I}_{D} = -17 \text{ A},$		4.2		nC
Q _{gd}	Gate-Drain Charge	V _{GS} = -10 V (Note 4)		10		nC
∝ga	Gale-Drain Charge	(10		
Drain-S	Source Diode Characteristics and Ma	aximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				-12	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward	d Current			-48	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -12 A			-4.0	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = -17 A,		92		ns
-						

NOTES:

Qrr

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 2.4 mH, I_{AS} = -12 A, V_{DD} = -25 V, R_G = 25 Ω , starting T_J = 25°C.

 $3.I_{SD} \leq~$ -17 A, di/dt \leq 300 A/µs, $V_{DD} \leq BV_{DSS},$ starting T $_J$ = 25°C.

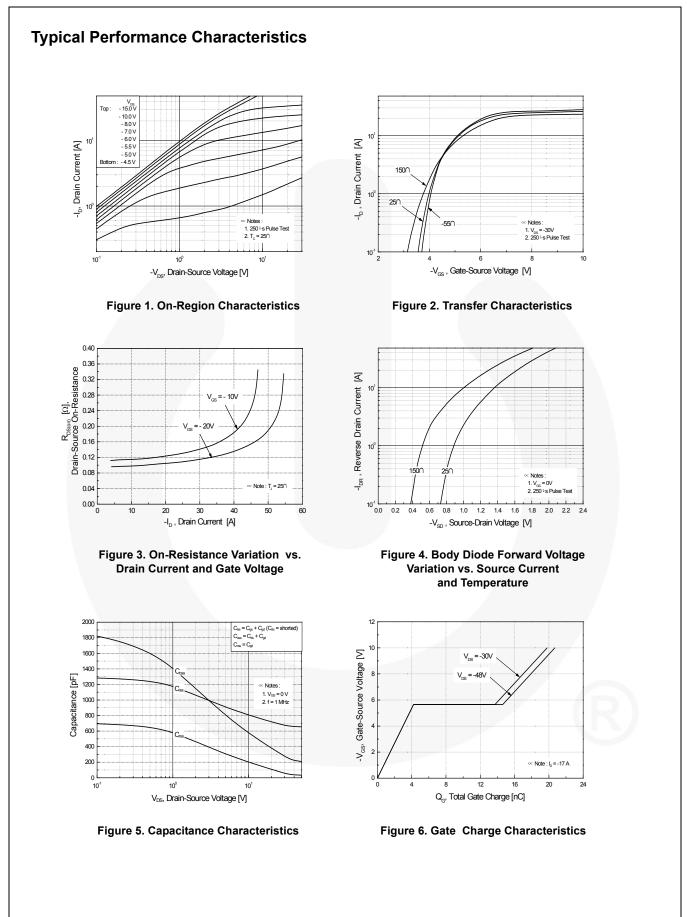
Reverse Recovery Charge

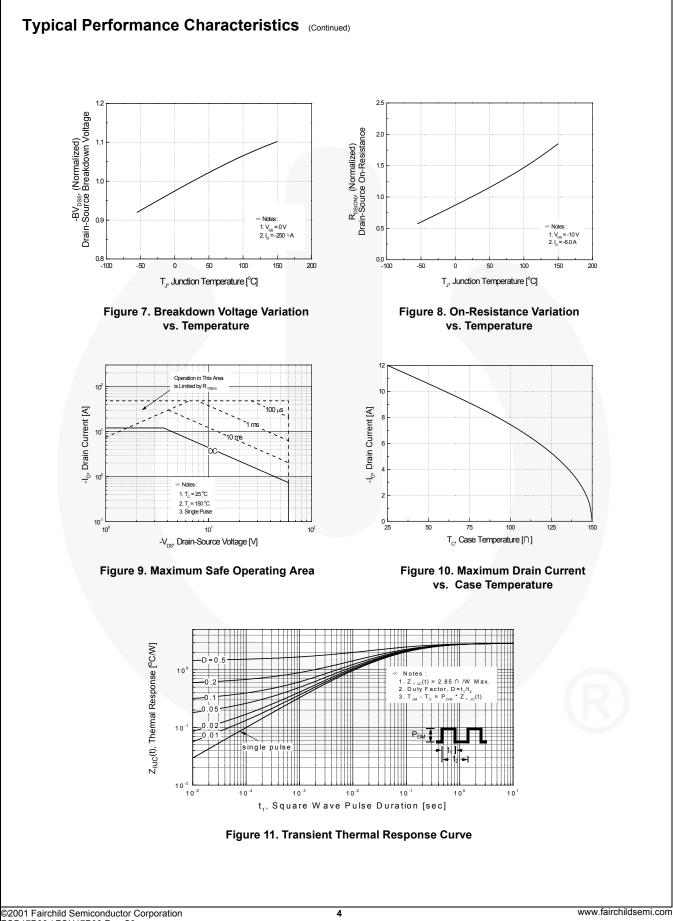
4. Essentially independent of operating temperature typical characteristics.

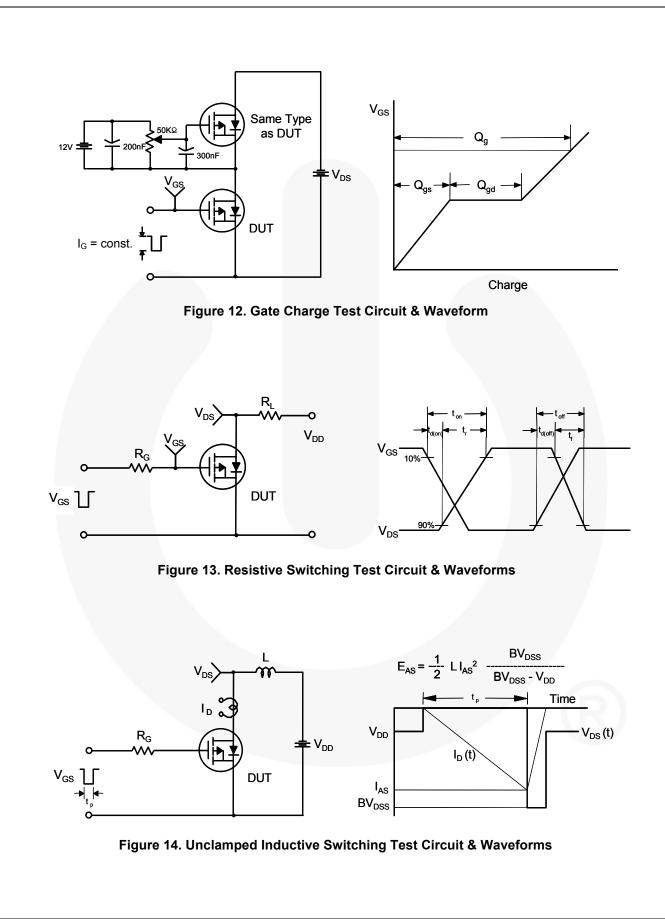
 $dI_{F} / dt = 100 \text{ A}/\mu \text{s}$

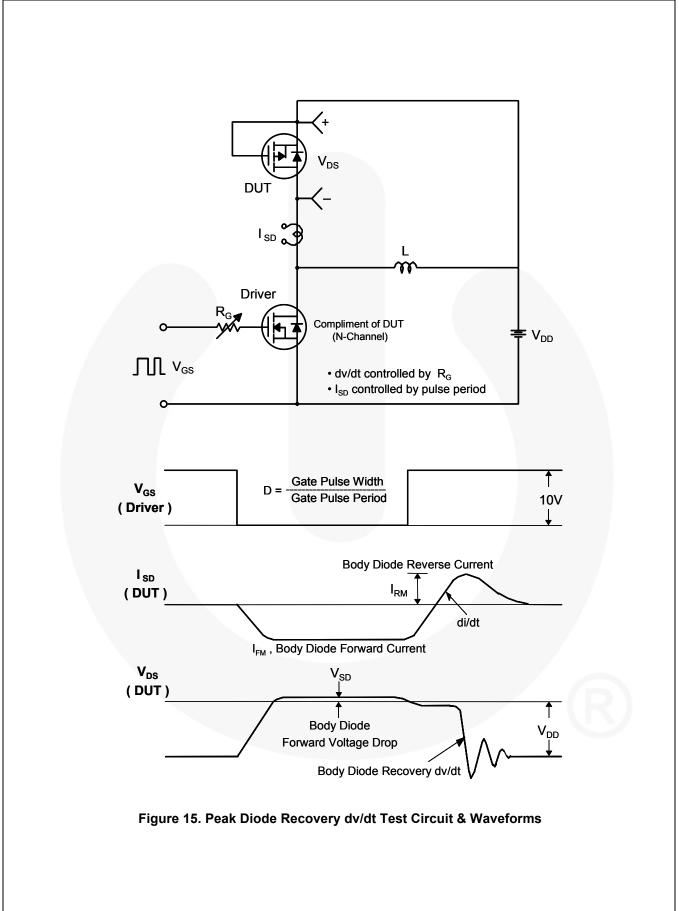
0.32

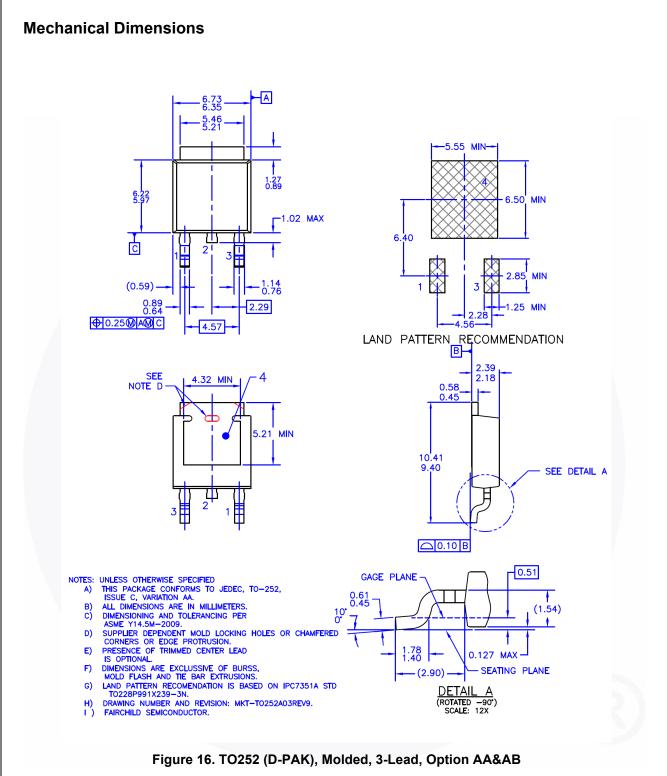
μC







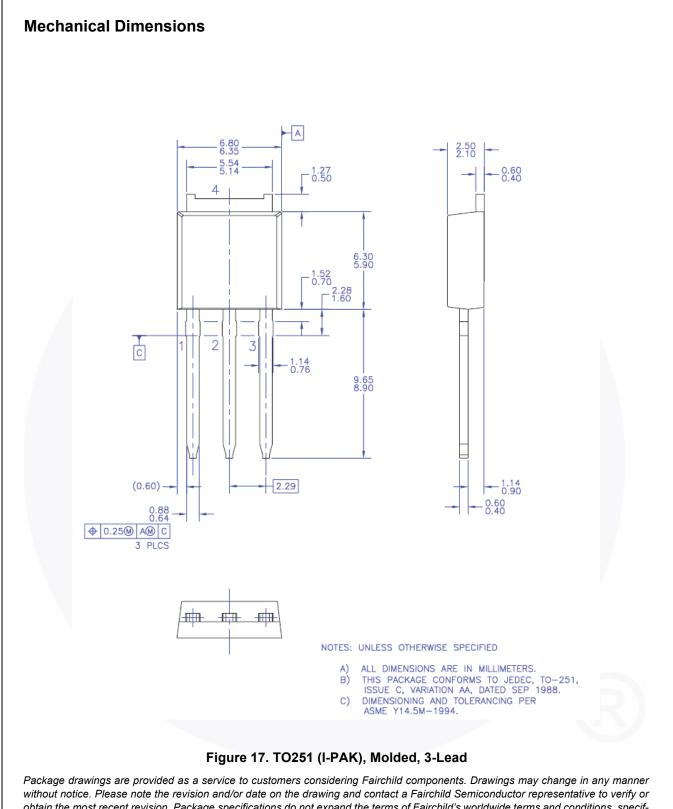




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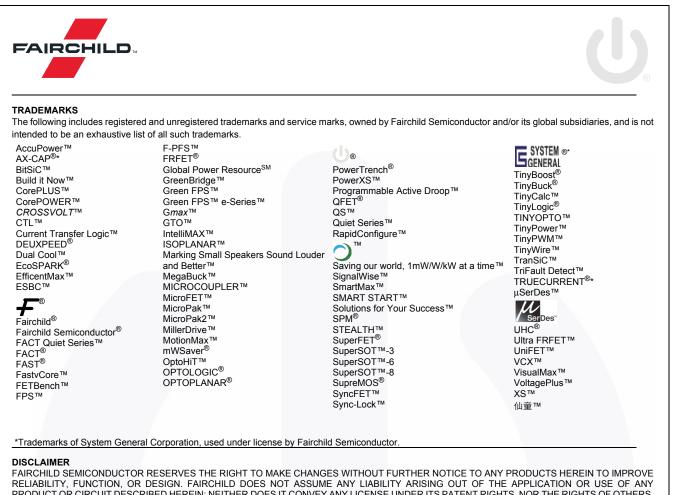
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QD17P06 / FQU17P06 —

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